

# **SERCOS Fiber Optic Transmitters and Receiver**

# Technical Data

#### **HFBR-0600 Series**

#### **Features**

- Fully Compliant to SERCOS Optical Specifications
- Optimized for 1 mm Plastic Optical Fiber
- Compatible with SMA Connectors
- Auto-Insertable and Wave Solderable
- Data Transmission at Symbol Rates from DC to over 2 MBd for Distances from 0 to over 20 Metres

### **Applications**

- Industrial Control Data Links
- Reduction of Lightning and Voltage Transient Susceptibility
- Tempest-Secure Data Processing Equipment
- Isolation in Test and Measurement Instruments
- Robotics Communication

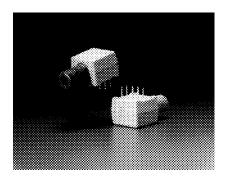
#### **SERCOS**

SERCOS is a SErial Realtime COmmunication System, a standard digital interface for communication between controls and drives for numerically controlled machines. The SERCOS interface specification was written by a joint working group of the VDW (German Machine Tool Builders Association) and ZVEI (German Electrical and Electronic Manufacturer's Association) to allow data exchange between NC controls and drives via fiber optic rings, with isolation and noise immunity. The HFBR-0600 family of fiber optic transmitters and receivers comply to the SERCOS specifications for transmitter and receiver optical characteristics and connector style (SMA).

#### **Description**

The HFBR-0600 components are capable of operation at symbol rates from DC to over 2 MBd and distances from 0 to over 20 metres. The HFBR-1602 and HFBR-1604 transmitters contain a 655-nm AlGaAs emitter capable of efficiently launching optical power into 1000  $\mu m$  plastic optical fiber. The optical output is specified at the end of 0.5 m of plastic optical fiber.

The HFBR-1604 is a selected version of the HFBR-1602, with power specified to meet the

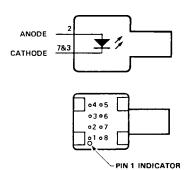


SERCOS high attenuation specifications.

The HFBR-2602 receiver incorporates an integrated photo IC containing a photodetector and dc amplifier driving an open-collector Schottky output transistor. The HFBR-2602 is designed for direct interfacing to popular logic families. The absence of an internal pull-up resistor allows the open-collector output to be used with logic families such as CMOS requiring voltage excursions higher than  $V_{\rm CC}$ . The HFBR-2602 has a dynamic range of 15 dB.

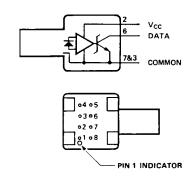
CAUTION: The small junction sizes inherent to the design of this component increase the component's susceptibility to damage from electrostatic discharge (ESD). It is advised that normal static precautions be taken in handling and assembly of this component to prevent damage and/or degradation which may be induced by ESD.

#### **HFBR-160X Transmitters**



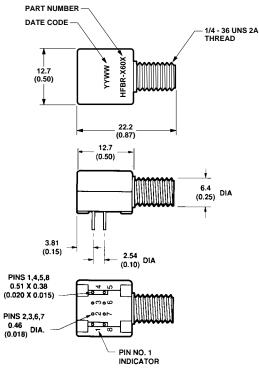
Pin	Function
1*	N.C.
2	ANODE
3	CATHODE
4*	N.C.
5*	N.C.
6	N.C.
7**	CATHODE
8*	N.C

#### HFBR-2602 Receiver

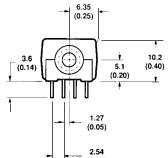


Pin	Function
1*	N.C.
2	V <sub>CC</sub> (5 V)
3	COMMON
4*	N.C.
5*	N.C.
6	DATA
7	COMMON
8*	N.C.

# HFBR-0600 SMA Series Mechanical Dimensions







\*Pins 1, 4, 5, and 8 are isolated from the internal circuitry, but electrically connected to one another.

In the receiver, both the open-collector "Data" output Pin 6 and  $V_{\rm CC}$  Pin 2 are referenced to "Common" Pin 3 and 7. It is essential that a bypass capacitor (0.1  $\mu F$  ceramic) be connected from Pin 2 ( $V_{\rm CC}$ ) to Pin 3 (circuit common) of the receiver.

SMA is an industry standard fiber optic connector, available from many fiber optic connector suppliers. HFBR-4401 is a kit consisting of 100 nuts and 100 washers for panel mounting the HFBR-0600 components.

<sup>\*\*</sup>Transmitter Pin 7 may be left unconnected if necessary.

# HFBR-1602/1604 Transmitters

# **Absolute Maximum Ratings**

Parameter		Symbol	Min.	Max.	Unit	Reference
Storage Temperature		$\mathrm{T_{S}}$	-55	85	$^{\circ}\mathrm{C}$	
Operating Temperature		$\mathrm{T_A}$	-40	85	°C	
Lead Soldering Cycle	Temp.			260	$^{\circ}\mathrm{C}$	Note 1
	Time			10	s	Note 1
Forward Input Current Peak		$I_{\mathrm{FPK}}$		120	mA	
Forward Input Current Average		$I_{Favg}$		60	mA	
Reverse Input Voltage		$V_{\mathrm{BR}}$		-5	V	

# **Electrical/Optical Characteristics** 0 to $55^{\circ}$ C, unless otherwise stated.

Parameter	Symbol	Min.	Typ.[2]	Max.	Unit	Condition	Reference
Forward Voltage	$V_{\rm F}$	1.5	1.9	2.2	V	$I_F = 35 \text{ mA}$	
Forward Voltage Temp. Coefficient	$\Delta V_{F}/\Delta T$		-1.2		mV/°C	$I_{\rm F} = 35 \text{ mA}$	
Reverse Input Voltage	$V_{ m BR}$	-5.0	-18		V	$I_R = 100 \mu A$	
Peak Emission Wavelength	$\lambda_{ m P}$	640	655	675	nm		
Full Width Half Maximum	FWHM		20	30	nm	25℃	
Diode Capacitance	$\mathrm{C}_{\mathrm{T}}$		30		pF	$V_{F} = 0$ $f = 1 \text{ MHz}$	
Optical Power Temp. Coefficient	$\Delta P_T/\Delta T$		-0.01		dBm/°C	$I_{\rm F} = 35 \text{ mA}$	
Thermal Resistance	$\theta_{ m JA}$		330		°C/W		Notes 3, 4
Peak Optical Output Power of HFBR-1602	P <sub>T1602</sub>	-10.5		-5.5	dBm	$I_F = 35 \text{ mA}$	Notes 5, 6, 11
Peak Optical Output Power of HFBR-1604	P <sub>T1604</sub>	-7.5 -10.5		-3.5 -5.5	dBm dBm	$I_F = 60 \text{ mA}$ $I_F = 35 \text{ mA}$	Notes 5, 6,
Rise Time (10% to 90%)	$t_r$		57 50		ns ns	$I_{\rm F} = 60 \text{ mA}$ $I_{\rm F} = 35 \text{ mA}$	
Fall Time (90% to 10%)	$t_{\rm f}$		40 27		ns ns	$I_{\rm F} = 60 \text{ mA}$ $I_{\rm F} = 35 \text{ mA}$	

# HFBR-2602 Receiver

# **Absolute Maximum Ratings**

Parameter		Symbol	Min.	Max.	Unit	Reference
Storage Temperature		$T_{\mathrm{S}}$	-55	85	$^{\circ}\mathrm{C}$	
Operating Temperature		$T_{A}$	-40	85	$^{\circ}\mathrm{C}$	
Lead Soldering Cycle	Temp.			260	°C	Note 1
Time				10	s	Note 1
Supply Voltage	Supply Voltage		-0.5	7.0	V	
Output Current	Output Current			25	mA	
Output Voltage		V <sub>O</sub>	-0.5	18.0	V	
Output Collector Power Dissipation		P <sub>O AVG</sub>		40	mW	
Fan Out (TTL)		N		5		Note 8

Electrical/Optical Characteristics 0 to 55°C; Fiber core diameter  $\leq 1.0$  mm, fiber N.A.  $\leq 0.5$ , 4.75 V  $\leq V_{CC} \leq 5.25$  V

Parameter	Symbol	Min.	<b>Typ.</b> [2]	Max.	Unit	Condition	Reference
High Level Output Current	$I_{OH}$		5	250	μA	$V_{OH} = 18 \text{ V}$ $P_{R} < -31.2 \text{ dBm}$	
Low Level Output Voltage	$V_{ m OL}$		0.4	0.5	V	$I_{OL} = 8 \text{ mA}$ $P_{R} > -20.0 \text{ dBm}$	
High Level Supply Current	$I_{CCH}$		3.5	6.3	mA	$V_{CC} = 5.25 \text{ V}$ $P_{R} < -31.2 \text{ dBm}$	
Low Level Supply Current	$I_{CCL}$		6.2	10	mA	$V_{CC} = 5.25 \text{ V}$ $P_{R} > -20.0 \text{ dBm}$	

# **Dynamic Characteristics** 0 to 55°C unless otherwise specified; $4.75~V \le V_{CC} \le 5.25~V$ ; BER $\le 10^{-9}$

Parameter	Symbol	Min.	<b>Typ.</b> [2]	Max.	Unit	Condition	Reference
Peak Input Power Level Logic HIGH	$P_{RH}$			-31.2	dBm	$\lambda_{\rm P} = 655 \text{ nm}$	Note 7
Peak Input Power Level Logic LOW	$P_{RL}$	-20.0		-5.0	dBm	$I_{OL} = 8 \text{ mA}$	Note 7
Propagation Delay LOW to HIGH	$ m t_{PLH}$		60		ns	$P_R = -20 \text{ dBm}$ 2 MBd	Note 8, 9
Propagation Delay HIGH to LOW	$ m t_{PHL}$		110		ns	$P_R = -20 \text{ dBm}$ 2 MBd	Note 8, 9
Pulse Width Distortion,	PWD		50		ns	$P_R = -5 \text{ dBm}$	Note 10 Figure 6
t <sub>PLH</sub> - t <sub>PHL</sub>			-50		ns	$P_R = -20 \text{ dBm}$	O

#### Notes:

- $1. \ \ 2.0 \ \mathrm{mm}$  from where leads enter case.
- 2. Typical data at  $T_A = +25$ °C.
- Thermal resistance is measured with the transmitter coupled to a connector assembly and fiber, and mounted on a printed circuit board.
- 4. Pins 2, 6, and 7 are welded to the cathode header connection to minimize the thermal resistance from junction to ambient. To further reduce the thermal resistance, the cathode trace should be made as large as is consistent with good RF circuit design.
- P<sub>T</sub> is measured with a large area detector at the end of 0.5 metre of plastic optical fiber with 1 mm

- diameter and numerical aperture of 0.5.
- When changing μW to dBm, the optical power is referenced to 1 mW (1000 μW). Optical Power P(dBm) = 10 log [P (μW)/1000 μW].
- Measured at the end of 1mm plastic fiber optic cable with a large area detector.
- 8. 8 mA load (5 x 1.6 mA),  $R_L = 560 \Omega$ .
- 9. Propagation delay through the system is the result of several sequentially occurring phenomena. Consequently it is a combination of data-rate-limiting effects and of transmission-time effects. Because of this, the data-rate limit of the system must be described
- in terms of time differentials between delays imposed on falling and rising edges. As the cable length is increased, the propagation delays increase. Datarate, as limited by pulse width distortion, is not affected by increasing cable length if the optical power level at the receiver is maintained.
- Pulse width distortion is the difference between the delay of the rising and falling edges.
- 11. Both HFBR-1602 and HFBR-1604 meet the SERCOS "low attenuation" specifications when operated at 35 mA; only HFBR-1604 meets the SERCOS "high attenuation" limits when operated at 60 mA.

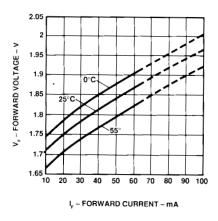


Figure 1. Forward Voltage and Current Characteristics.

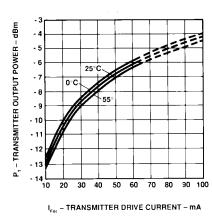


Figure 2. Typical Transmitter Output vs. Forward Current.

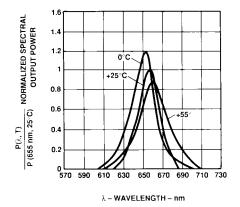


Figure 3. Transmitter Spectrum Normalized to the Peak at 25°C.

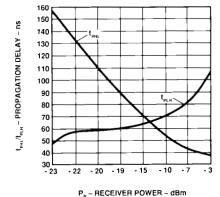


Figure 4. Typical Propagation Delay through System with 0.5 Metre of Cable.

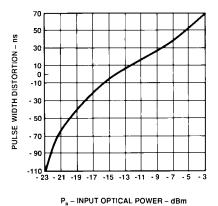


Figure 5. Typical HFBR-160X/2602 Link Pulsewidth Distortion vs. Optical Power.



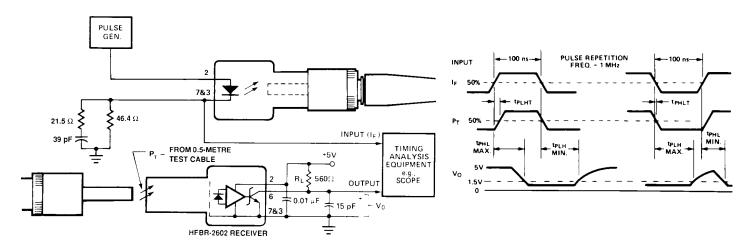


Figure 6. System Propagation Delay Test Circuit and Waveform Timing Definitions.

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